

RN73R

precision thin (metal) film flat chip resistors (high reliability)

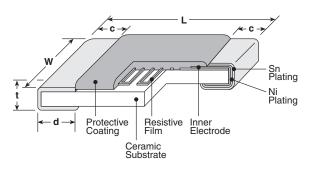


features



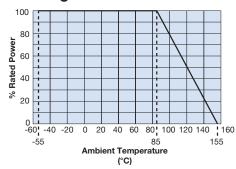
- High reliability with ΔR of ±0.1% \sim ±0.25% in the long-term reliability test
- Endurance at 85°C (1,000h): ΔR of ±0.1%
- Operating temperature range ~ 155°C
- Rated ambient temperature: 85°C
- High precision type ±0.05% is also available
- Low current noise
- · Improved moisture resistance by high humidity protective coating
- · Suitable for control circuits in various industrial equipment
- Sulfur resistance verified according to ASTM B 809-95
- Products meet EU RoHS requirements
- AEC-Q200 Tested

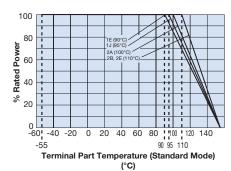
dimensions and construction

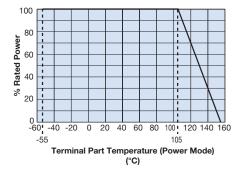


Туре	Dimensions inches (mm)							
(Inch Size Code)	L	W	С	d	t			
1E (0402)	.039 +.004 002 (1.0 _{-0.05})	.020±.002 (0.5±0.05)	.010±.004 (0.25±0.1)	.010 +.002 004 (0.25 +0.05)	.014±.002 (0.35±0.05)			
1J (0603)	.063±.008 (1.6±0.2)	.031±.004 (0.8±0.1)	.012±.004 (0.3±0.1)	.012±.004 (0.3±0.1)	.018±.004 (0.45±0.1)			
2A (0805)	.079±.008 (2.0±0.2)	.049±.008 (1.25±0.2)	.016±.008 (0.4±0.2)	.012 +.008 004 (0.3 +0.2)	.02±.004 (0.5±0.1)			
2B (1206)	.126±.008 (3.2±0.2)			.016 +.008 004 (0.4 +0.2)	.024±.004 (0.6±0.1)			
2E (1210)	.126±.008 (3.2±0.2)	.098±.008 (2.5±0.2)	.02±.012 (0.5±0.3)	.016 +.008 004 (0.4 +0.2)	.024±.004 (0.6±0.1)			

Derating Curve







For resistors operated at an ambient temperature of 85°C or above, a power rating shall be derated in accordance with the above derating curve.

When the terminal part temperature of the resistor exceeds the rated terminal part temperature shown above, the power shall be derated according to the derating curve. Please refer to "Introduction of the derating curves based on the terminal part temperature" on the beginning of our catalog before use.

ordering information

RN73R	2B	T
Туре	Size	Termination Material
	1E	T: Sn
	1J	
	2A	
	2B	
	2E	

TD	
Packaging	
TP: 2mm pitch punched paper	
TD: 4mm pitch punched paper	
TE: 4mm pitch plastic embossed	
For further information on packaging, please refer to Appendix A	

1002						
Nominal Resistance						
fiç 1	significant gures + multiplier					
de	R" indicates ecimal on alue <1000					

Resistance
Tolerance
A: ±0.05%
B: ±0.1%
C: ±0.25%
D: ±0.5%
F: ±1.0%

T.C.R. (ppm/°C)						
05						
10						
25						
50						
100						

Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.

8/20/24





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applications and ratings

Part Designation	Power Rating	Rated Ambient	Rated Terminal	T.C.R.	E 24, E 30, E 132				Maximum Working	Maximum Overload	
Designation	@ 85°C	Temp.	Part Temp.	(x10 ⁻⁶ /K	(A±0.05%)	(B±0.1%)	(C±0.25%)	(D±0.5%)	(F±1.0%)	Voltage	Voltage
				±10	_	47~10k	47~10k	47~10k	47~10k		
	0.063W	85°C	90°C	±25	_	47~300k	47~300k	47~300k	47~300k	50V	100V
RN73H1E				±50	_	47~300k	47~300k	10~300k	10~300k		
HIV/SITIE		_	_	±10	_	47~10k	47~10k	47~10k	47~10k		
	0.1W	85°C	105°C	±25	_	47~300k	47~300k	47~300k	47~300k	50V	100V
				±50	 100~59k	47~300k 100~59k	47~300k	47~300k	47~300k		
				±5			47.50	- 47. 501	47.50		
		0500	0500	±10 ±25	47~59k 47~59k	47~59k 15~1M	47~59k 15~1M	47~59k 10~1M	47~59k 10~1M	75.7	45014
	0.1W	85°C	95°C	±25 ±50	47~59K —	15~1M	15~1M	10~1M 10~1M	10~1M 10~1M	75V	150V
				±30	_	15~11VI	15~1W	10~1M	10~1M	-	
RN73H1J				±100	 100~59k	 100~59k	_	10~11VI —	10~11VI		
				±10	47~59k	47~59k	47~59k	47~59k	47~59k	-	
	0.125W	85°C	105°C	±25	47~59k	47~1M	47~1M	47~1M	47~1M	75V	150V
	0.125	05 C	105 C	±50		47~1M	47~1M	47~1M	47~1M	/50	1507
				±100	_			47~1M	47~1M	1	
				±5	100~100k	100~100k	_	_			
				±10	47~100k	47~100k	47~100k	47~100k	47~100k	1	
	0.125W	85°C	100°C	±25	47~100k	15~1.5M	15~1.5M	10~1.5M	10~1.5M	150V	300V
	0.125	00 0	100 0	±50	_	15~1.5M	15~1.5M	10~1.5M	10~1.5M	1001	000 \$
DNITCLICA				±100	_	_	_	10~1.5M	10~1.5M	1	
RN73H2A				±5	100~100k	100~100k	_	_	_		
				±10	47~100k	47~100k	47~100k	47~100k	47~100k]	
	0.25W	85°C	105°C	±25	47~100k	47~1.5M	47~1.5M	47~1.5M	47~1.5M	150V	300V
				±50	_	47~1.5M	47~1.5M	47~1.5M	47~1.5M		
				±100	_		_	47~1.5M	47~1.5M		
				±5	100~300k	100~300k	_	_	_		
				±10	47~300k	47~300k	47~300k	47~300k	47~300k		
	0.25W	85°C	110°C	±25	47~300k	15~1M	15~1M	10~1M	10~1M	200V	400V
				±50	_	15~1M	15~1M	10~1M	10~1M		
RN73H2B				±100 ±5	 100~300k	 100~300k	_	10~1M	10~1M		
THEFT				±5 ±10	47~300k	47~300k	47~300k	 47~300k	- 47~300k		
		0500	40500	±10 ±25	47~300k 47~300k	47~300K 47~1M	47~300k 47~1M	47~300K 47~1M	47~300k 47~1M	0001/	4001/
	0.4W	85°C	105°C	±25 ±50	47~300K	47~1M	47~1M	47~1M	47~1M	200V	400V
				±30 ±100		4/~1IVI	4/~11VI	47~1M	47~1M	-	
				±100	100~510k	100~510k	100~510k	100~510k	100~510k		
C	0.25W	85°C	110°C	±25	51~510k	15~1M	15~1M	10~1M	10~1M	200V	400V
				±50		15~1M	15~1M	10~1M	10~1M		
				±100	_		_	10~1M	10~1M		
RN73H2E				±10	100~510k	100~510k	100~510k	100~510k	100~510k		
		85°C	105°C	±25	51~510k	47~1M	47~1M	47~1M	47~1M	200V	400V
	0.5W			±50	_	47~1M	47~1M	47~1M	47~1M		
				±100	_	_	_	47~1M	47~1M		

Operating Temperature: -55° C to $+155^{\circ}$ C. Rated voltage = $\sqrt{\text{Power rating x resistance value}}$ or max. working voltage, whichever is lower. If any questions arise whether to use the "Rated Ambient Temperature" or the "Rated Terminal Part Temperature" in your usage conditions, please give priority to the "Rated Terminal Part Temperature".

environmental applications - Performance Characteristics

D	Requirement Δ R ±(%+0.05Ω)		To a Markey of			
Parameter	Limit	Typical	Test Method			
Resistance	Within specified tolerance	-	25°C			
T.C.R.	Within specified T.C.R.	-	+25°C/+125°C: T.C.R. +5 (x10°K); +25°C/-55°C and +25°C/+155°C: others			
	Standard Mode: ±0.05%	±0.01%	Rated Voltage x 2.5 or Max. overload voltage, whichever is less, for 5 seconds			
Overload (Short time)			1E, 1J: Rated voltage ×2.0 or Max overload voltage, whichever is less, for 5 seconds 2A,2B, 2E: Rated voltage ×1.5 or Max overload voltage, whichever is less, for 5 seconds			
Resistance to Solder Heat	±0.5%**	±0.01%	260°C ± 5°C, 10 seconds ± 1 second			
Rapid Change of Temperature	±0.1%**	±0.04%	1E, 1J, 2A: -55°C (30 minutes), +155°C (30 minutes), 1000 cycles 2B, 2E: -55°C (30 minutes), +155°C (30 minutes), 500 cycles			
Moisture Resistance	Standard Mode: ±0.25%**	±0.07%	85°C±2°C, 85%±5%RH, 1000h. Rated voltage or Max working voltage, whichever is less.1.5h ON/0.5h OFF cycle			
Woisture nesistance	Power Mode: ±0.25%**	±0.06%	85°C±2°C, 85%±5%RH, 1000h. Rated power x0.1 or Max working voltage, whichever is less			
Endurance at 85°C	Standard Mode: 0.1%	±0.04%	Rated terminal part temp. ±2°C or Rated ambient temp. 85°C±2°C, 1000h 1.5h ON/0.5h OFF cycle			
Liluurance at 65 C	Power Mode: ±0.2%	±0.05%	Rated terminal part temp. ±2°C or Rated ambient temp. 85°C±2°C, 1000h 1.5h ON/0.5h OFF cycle			
High Temperature Exposure	±0.25%**	±0.10%	+155°C, 1000 hours			

Precautions for Use

** Depends on resistance value, please contact KOA Speer for details.

- The properly and electrostatically measured taping materials are used for the components, but attention should be paid to the fact that there is some danger the parts absorb on the top tapes to cause a failure in the mounting and the parts are destructed by static electricity (1.1, 2A, 2B, 2E: 1kV and more, 1E: 0.5kV and more at Human Body Model 100pF, 1.5kQ) to change the resistance in the conditions of an excessive dryness or after the parts are given vibration for a long time as they are packaged on the tapes. Similarly, care should be given not to apply the excessive state electricity when mounting on the boards.

 In onic impurities such as flux etc. that are attached to these products or those mounted onto a PCB, negatively affect their moisture resistance, corosion resistance, etc. The flux may contain ionic substances like chlorine, acid, etc. while perspiration and saliva include ionic impurities like sodium (Na¹), chlorine (Ci) etc. Therefore these kinds of ionic substances may induce electrical corrosion when they invade into the products. Either thorough washing or using RNA solder and flux are necessary since lead free solder contains ionic substances. Washing pross is needed, before putting on moisture proof material in order to prevent electrical corrosion.

 The upper electrodes could be peeled off when a heat-resistant masking tape is attached to the mounted chip resistors and then detached from them. It is confirmed that the adhesiveness gets stronger due to the exposure to heat under mounted chip resistant masking tape is unavoidable please make sure that the adhesives on the tape to not directly come in contact the product the product the product when the mounted chip the product will be product.
- under mounting. Accordingly, we recommend the use of masking tape be refrained. If the use of heat-resistant masking tape is unavoidable, please make sure that the admissives on the tape do not directly come in contact with the product.

 When high-pressure shower cleaning is implemented, there is a possibility of exclusion of the top electrodes caused by the water pressure stress so please avoid the implementation.

 If the implementation is unavoidable, then please evaluate the products beforehand.

For Surface Temperature Rise Graph see Environmental Applications. Additional environmental applications can also be found at www.koaspeer.com Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use. 8/20/24